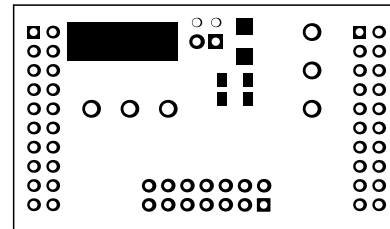
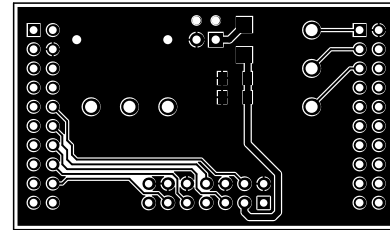


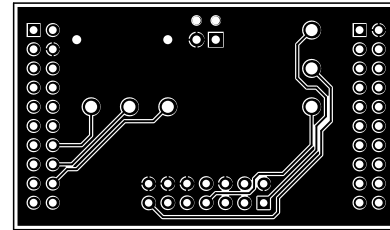
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01527	REV: E1	SVN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #:		
PLOT NAME = Top Overlay	GENERATED : 13-Mar-18 2:01:52 PM	TEXAS INSTRUMENTS	



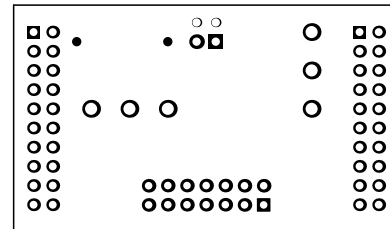
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01527	REV: E1	SVN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #:		
PLOT NAME = Top Solder Mask	GENERATED : 13-Mar-18 2:01:53 PM	TEXAS INSTRUMENTS	



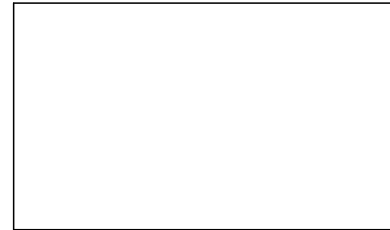
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01527	REV: E1	SVN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #:		
PLOT NAME = Top Layer	GENERATED : 13-Mar-18 2:01:55 PM	TEXAS INSTRUMENTS	



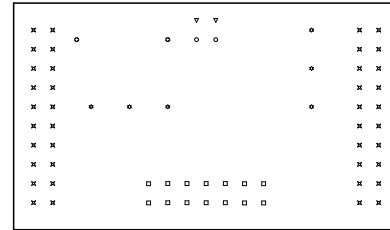
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01527	REV: E1	SVN REV: Not In VersionControl
LAYER NAME = Bottom Layer	TID #:		
PLOT NAME = Bottom Layer	GENERATED : 13-Mar-18 2:01:56 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01527	REV: E1	SVN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #:		
PLOT NAME = Bottom Solder Mask	GENERATED : 13-Mar-18 2:01:57 PM	TEXAS INSTRUMENTS	

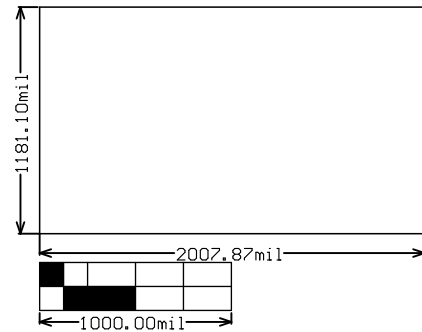


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01527	REV: E1	SVN REV: Not In VersionControl
LAYER NAME = Bottom Overlay	TID #:		
PLOT NAME = Bottom Overlay	GENERATED : 13-Mar-18 2:01:58 PM	TEXAS INSTRUMENTS	



Symbol	Quantity	Finished Hole Size	Plated	Hole Type
▽	2	43.31mil (1.100mm)	NPTH	Round
□	14	39.37mil (1.000mm)	PTH	Round
⊗	40	40.95mil (1.040mm)	PTH	Round
○	2	43.31mil (1.100mm)	PTH	Round
⊕	2	47.24mil (1.200mm)	PTH	Round
☆	6	63.00mil (1.600mm)	PTH	Round
	66 Total			

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01527	REV: E1	SVN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #:		
PLOT NAME = Drill Drawing	GENERATED : 13-Mar-18	2:01:59 PM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01527	REV: E1	SVN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions	TID #:		
PLOT NAME = Board Dimensions	GENERATED : 13-Mar-18 2:02:00 PM	TEXAS INSTRUMENTS	

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